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Transistors with Built-in Resistor DRC5152Z0L

DRC5152Z0L Silicon NPN epitaxial planar type

For digital circuits Complementary to DRA5152Z DRC2152Z in SMini3 type package

Features

- Low collector-emitter saturation voltage Vce(sat)
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: N0

Packaging

Collector current

Total power dissipation

Operating ambient temperature

Junction temperature

Storage temperature

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

Symbol

VCBO

VCEO

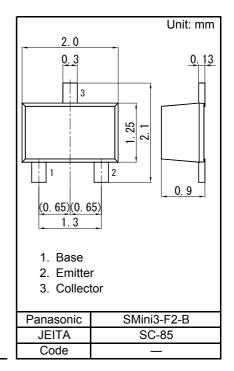
IC

PT

Tj

Topr

Tstg



Internal Connection							
Resistance	R1	0.51	kΩ				
value	R2	5.1	kΩ				

Electrical Characteristics Ta = $25 \circ C \pm 3 \circ C$

Absolute Maximum Ratings Ta = 25 °C

Parameter

Collector-base voltage (Emitter open)

Collector-emitter voltage (Base open)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	VCBO	IC = 10 µA, IE = 0	50			V
Collector-emitter voltage (Base open)	VCEO	IC = 2 mA, IB = 0	50			V
Collector-base cutoff current (Emitter open)	ICBO	VCB = 50 V, IE = 0			0.1	μA
Collector-emitter cutoff current (Base open)	ICEO	VCE = 50 V, IB = 0			0.5	μA
Emitter-base cutoff current (Collector open)	IEBO	VEB = 6 V, IC = 0			2.0	mA
Forward current transfer ratio	hFE	VCE = 10 V, IC = 5 mA	20			-
Collector-emitter saturation voltage	VCE(sat)	IC = 10 mA, IB = 0.5 mA			0.25	V
Input voltage	Vi(on)	VCE = 0.2 V, IC = 5 mA	1.0			V
	Vi(off)	VCE = 5 V, IC = 100 µA			0.4	V
Input resistance	R1		-30%	0.51	+30%	kΩ
Resistance ratio	R1/R2		0.08	0.10	0.12	-

Rating

50

50

100

150

150

-40 to +85 -55 to +150 Unit

V

V

mΑ

mW

°C C°

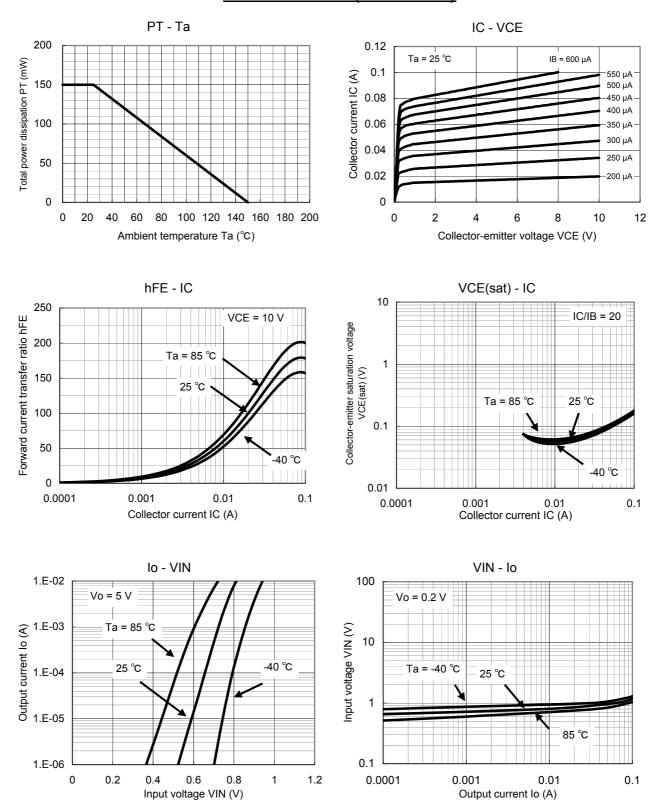
°C

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

Transistors with Built-in Resistor DRC5152Z0L



Technical Data (reference)



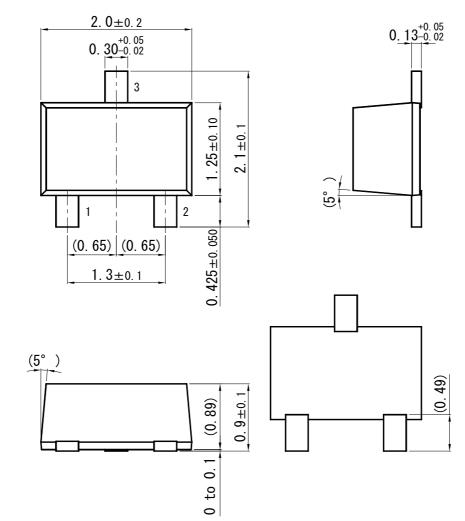
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Established : 2009-10-15 Revised : 2014-03-14

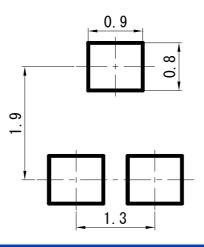


Transistors with Built-in Resistor DRC5152Z0L

Unit: mm



Land Pattern (Reference) (Unit: mm)



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SMini3-F2-B

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